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9/15/03
Mullish
PATENT



42390.P6623

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ma, et al.

Application No.: 09/374,502

Confirmation No.: 3832

Filed: August 13, 1999

For: Isolation Structure Configurations for
Modifying Stresses in Semiconductor
Devices

Examiner: Jesse Fenty

Group Art Unit: 2815

Attorney Docket No.: 42390.P6623

CERTIFICATE OF MAILING

I hereby certify that this paper or fee along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner of Patents and Trademarks, P.O. Box 1450, Alexandria, VA 22313-1450.

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DEBORAH L. HIGHAM
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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed May 28, 2003, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims, which begin on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.

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